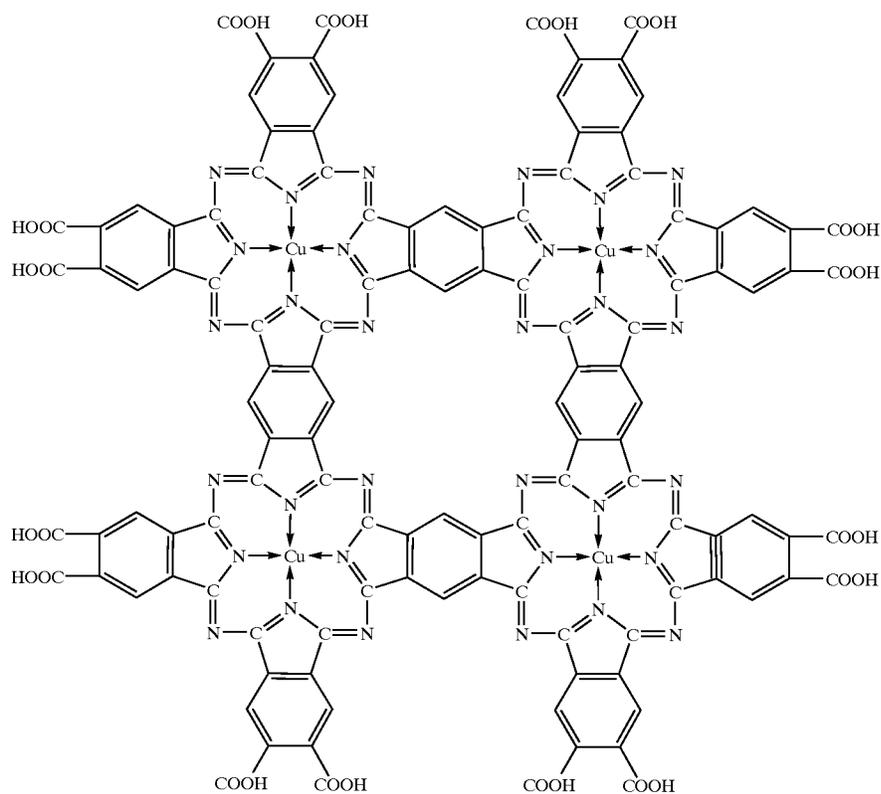


13

14



wherein Cu is copper.

**28.** A composite material comprising:

a polymer matrix; and

at least one high-dielectric constant organic material having a dielectric constant higher than 1.000;

wherein said composite exhibits a strain of about 2% under an electric field of 13 MV/m or higher.

**29.** A material comprising a polymer matrix and at least one high-dielectric constant organic material having a dielectric constant higher than 1.000; wherein said Polymer matrix and said high-dielectric constant material are chemically bonded to form said material; and wherein said composite exhibits a strain of about 2% under an electric field of 13 MV/m or higher.

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